

### **PSE Technology Corporation**

### SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	30.000000 MHz
PRODUCT TYPE	TYPE FW 2.0x1.6 SEAM SEALED CRYSTAI
PART NUMBER	FW300010
CUSTOMER P/N	
ISSUE DATE	October 23, 2012
VERSION	С

APPROVED	PREPARED	QA
Alan Yang	Brenda	Bedrycri
	APPROVED BY CLISTOMER	

Please return one copy with approval to PSE-TW

### **PSE Technology Corporation**

No.2, Tzu-Chiang 5th Rd., Chung Li Industrial Park, Chung Li City, Taoyuan County, Taiwan (R.O.C.) TEL:886-3-451-8888 FAX:886-3-461-3865 http://www.saronix-ecera.com.tw/

- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant

A Company of PERICOM Semiconductor Corporation

E0-R-4-014 Rev.E

VER.C 23-OCT-12

#### **VERSION HISTORY**

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Oct. 11, 2012			Initial Release	
В	Oct. 12, 2012		Changed operating drive level from 100uW to 200uW & maximum drive level from 150uW to 200uw.		
С	Oct. 23, 2012		Changed Maximum Drive Level from 200uW to 300uW		

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#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	30.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	10	pF	
Calibration Tolerance	FL	± 30	ppm	at 25°C±3°C
Operating Temperature Range	TR	-20 to +70	°C	
Frequency Stability(Frequency Deviation over the Operating Temperature Range)	F/T	± 30	ppm	Reference to the Frequency at 25°C
Operating Drive Level		200	μW	
Maximum Drive Level		300	μW	
Equivalent Series Resistance	ESR	45	Ω	Max.
Shunt Capacitance	C0	7	pF	Max.
Spurious Modes Suppression in dB (12.5Ω fixture)	SPDB	6	dB	Min, down from the main mode
Q-Factor	Q	20K to 200K		
Aging at 25°C		± 3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

<sup>\*\*</sup> This product doesn"t include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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#### RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a)FINE LEAK TEST: JESD22-A109 (Condition 1A)

b)GROSS LEAK TEST: JESD22-A109 (Condition C)

c)MOISTURE RESISTANCE: JESD22-A113

d)SHOCK: JESD22-B104 (Condition B)

e)SOLDERABILITY: (RoHS version): J-STD-002

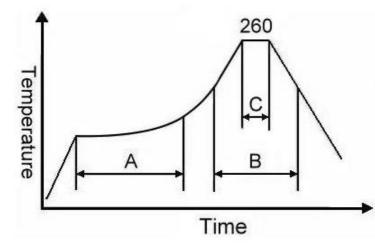
f)VIBRATION: JESD22-B103

g)SOLVENT RESISTANCE: JESD22-B107

h)RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



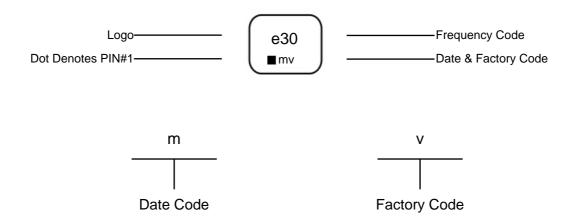
vote.		
	Stage	Te

	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

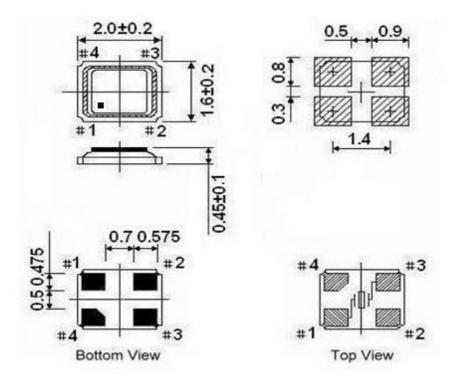
For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

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#### **MARKING**



#### MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



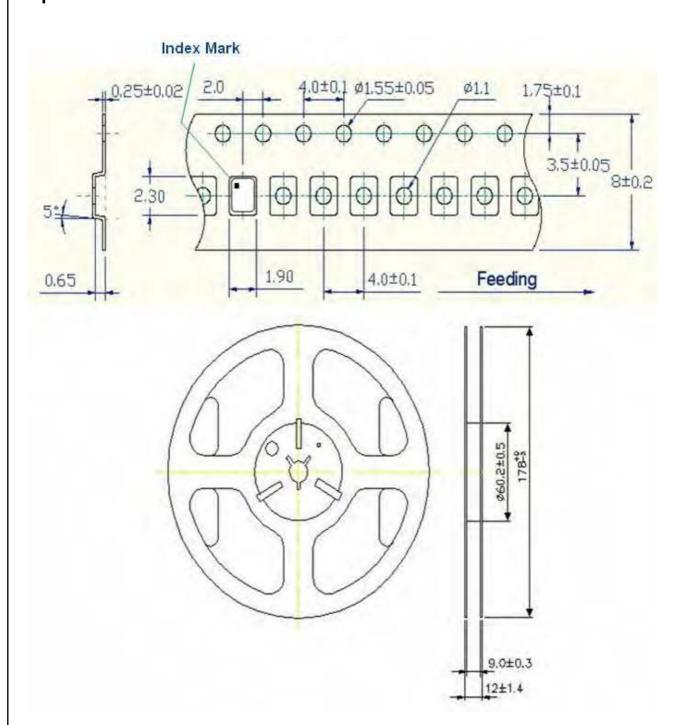
\*\* Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

#### Note:

- 1. The marking dot denotes Pin#1.
- Pin positions of the drawing is only for reference, and the Pin with chamfer is based on the real product.

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### Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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